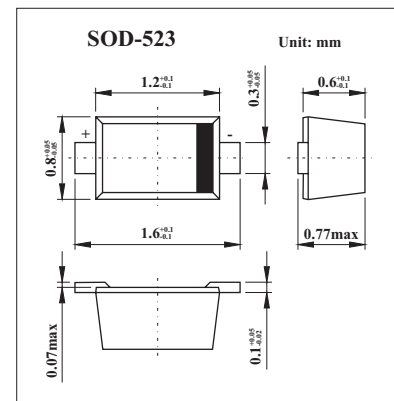


Silicon Schottky Barrier Diode

HSC226

■ Features

- Low reverse current, Low capacitance.
- Ultra small Flat Package (UFP) is suitable for surface mount design.

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Value | Unit |
|---|-------------|-------------|------------------|
| Repetitive peak reverse voltage | V_{RRM} | 25 | V |
| Non-Repetitive peak forward surge current | I_{FSM}^* | 200 | mA |
| Forward current | I_F | 50 | mA |
| Junction temperature | T_j | 125 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -55 to +125 | $^\circ\text{C}$ |

Note

10ms Sinewave 1pulse

■ Electrical Characteristics $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|-----------------|--------|--------------------------------------|-----|-----|------|----------------|
| Forward voltage | V_F | $I_F = 1\text{ mA}$ | | | 0.33 | V |
| | | $I_F = 5\text{ mA}$ | | | 0.38 | |
| Reverse current | I_R | $V_R = 20\text{ V}$ | | | 0.45 | $\mu\text{ A}$ |
| Capacitance | C | $V_R = 1\text{ V}, f = 1\text{ MHz}$ | | | 2.80 | pF |

■ Marking

| | |
|---------|----|
| Marking | S4 |
|---------|----|